

**TRADEMARK ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT		
<b>NATURE OF CONVEYANCE:</b>	Grant of Trademark Security Interest (IP Supplement No. 8)		
<b>CONVEYING PARTY DATA</b>			
<b>Name</b>	<b>Formerly</b>	<b>Execution Date</b>	<b>Entity Type</b>
Hexcel Corporation		05/24/2007	CORPORATION: DELAWARE
<b>RECEIVING PARTY DATA</b>			
<b>Name:</b>	Deutsche Bank Trust Company Americas, as Administrative Agent		
<b>Street Address:</b>	60 Wall Street		
<b>Internal Address:</b>	NYC60-1104		
<b>City:</b>	New York		
<b>State/Country:</b>	NEW YORK		
<b>Postal Code:</b>	10005		
<b>Entity Type:</b>	CORPORATION: DELAWARE		
<b>PROPERTY NUMBERS Total: 1</b>			
<b>Property Type</b>	<b>Number</b>	<b>Word Mark</b>	
<b>Serial Number:</b>	77126738	HEXTOW	
<b>CORRESPONDENCE DATA</b>			
<b>Fax Number:</b>	(213)430-6407		
	<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>		
<b>Phone:</b>	212-408-2434		
<b>Email:</b>	hstrassberg@omm.com		
<b>Correspondent Name:</b>	Mark Wlazlo		
<b>Address Line 1:</b>	7 Times Square		
<b>Address Line 2:</b>	O'Melveny & Myers, LLP		
<b>Address Line 4:</b>	New York, NEW YORK 10036		
<b>ATTORNEY DOCKET NUMBER:</b>	212402-009		
<b>NAME OF SUBMITTER:</b>	Mark Wlazlo		
<b>Signature:</b>	/Mark Wlazlo/		

CH \$40.00 77126738

Date:

06/07/2007

Total Attachments: 2

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## IP SUPPLEMENT NO. 8

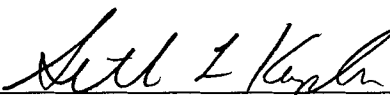
This **IP SUPPLEMENT NO. 8**, dated as of May 24, 2007, is delivered by Hexcel Corporation, a Delaware corporation located at Two Stamford Plaza, 16<sup>th</sup> Floor, 281 Tresser Blvd., Stamford, CT 06901 (the “**Grantor**”), to Deutsche Bank Trust Company Americas, as Administrative Agent and representative of the Beneficiaries (in such capacity, the “**Secured Party**”), pursuant to and in supplement of (i) the Security Agreement, dated as of March 1, 2005 (said Security Agreement, as it may heretofore have been and as it may hereafter be further amended, restated, supplemented or otherwise modified from time to time, being the “**Security Agreement**”), among Grantor, the other grantors named therein, and Secured Party, (ii) the Grant of Patent Security Interest, dated as of March 1, 2005, among Grantor, Hexcel Reinforcements Corp. and Secured Party, and (iii) the Grant of Trademark Security Interest, dated as of March 1, 2005, between Grantor and Secured Party (collectively, together with all IP Supplements entered into since March 1, 2005, the “**Grants**”). Capitalized terms used herein not otherwise defined herein shall have the meanings ascribed thereto in the Grants.

**NOW THEREFORE**, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, subject to the terms and conditions of the Security Agreement, to evidence further the security interest granted by Grantor to Secured Party pursuant to the Security Agreement, Grantor grants to Secured Party a security interest in all of Grantor’s right, title and interest in and to the Trademark Collateral and Patent Collateral set forth on Schedule A annexed hereto. All such Trademark Collateral and Patent Collateral shall be deemed to be part of the Trademark Collateral and Patent Collateral, respectively, and shall be hereafter subject to each of the terms and conditions of the Security Agreement and the Grants.

Grantor does hereby further acknowledge and affirm that the rights and remedies of Secured Party with respect to the security interest in the Trademark Collateral and Patent Collateral granted hereby are more fully set forth in the Security Agreement, the terms and provisions of which are incorporated by reference herein as if fully set forth herein.

**IN WITNESS WHEREOF**, Grantor has caused this IP Supplement No. 8 to be duly executed and delivered by its officer thereunto duly authorized as of the date hereof.

HEXCEL CORPORATION

By: 

Name: Seth L. Kaplan

Title: Assistant Secretary

**Schedule A**  
to  
**IP Supplement No. 8**  
**Dated as of May 24, 2007**

**Patent Applications**

<b>Title</b>	<b>Country</b>	<b>Application No./Date Filed</b>	<b>Grant Date/No.</b>
Helicopter blade mandrel	U.S.	11/645884 12/27/2006	
Acoustic septum cap honeycomb	U.S.	11/726451 3/22/2007	
Fiber reinforced resin assembly	U.S.	11/784718 04/09/2007	
Pre-impregnated composite materials	U.S.	11/787700 04/17/2007	
Composite material with blend of thermoplastic particles	U.S.	11/787701 04/17/2007	

**Trademark Applications**

<b>Title</b>	<b>Country</b>	<b>Application No./Date Filed</b>	<b>Grant Date/No.</b>
HEXTOW	U.S.	77126738 3/9/2007	